



Lab Testing Capabilities

Work with Adhesives Experts

Henkel offers best-in-class product development and troubleshooting from our world-class Analytical Lab Solutions Group and on-site facilities.

- Collaborate with our technical experts
- Receive immediate testing and evaluation of your product trials on our end of line and labeling test equipment.

| EoL | Capability Description |
|-----------------|---|
| Case Sealer | <ul style="list-style-type: none"> • Simulates a production line for case and carton sealing, allowing to test in-house prior to using plant resources • Application amount, line speed and compression quality can be tested to replicate production line conditions • Samples generated from this equipment are used to validate adhesive performance under different conditions |
| Box Pull Tester | <ul style="list-style-type: none"> • Simulates a box being pulled open for evaluation of bond strength • Determine the efficacy of various bead sizes and patterns • Ability to test specific customer packages |
| Drum Coater | <ul style="list-style-type: none"> • Simulates an actual production line for adhesive application • Improves prediction of adhesive machinability (clean vs. messy) during extrusion and substrate application • Factors that can be varied include adhesive application amount (both length & thickness of bead), temperature and line speed |
| Adhesion | <ul style="list-style-type: none"> • Test performed by hand to evaluate if an adhesive will adhere to a specific substrate • Samples can also be tested at different temperature conditions specific to the end-use requirement • Adhesion is rated using % fiber tear, strength of bond and depth of fiber tear |
| Kanebo | <ul style="list-style-type: none"> • Automated equipment used to measure hot tack, open time and set speed of a hot melt adhesive • Shows the change in tack of a hot melt with change in application temperature and bead size |
| Instron | <ul style="list-style-type: none"> • Automated tensile tester evaluates bond strength of hot melt or water-based bonds applied to various substrates |

| Labeling | Capability Description |
|----------------------------|---|
| Water-based Labeler | <ul style="list-style-type: none"> • Adhesive is run on a labeler to evaluate the machinability, re-circulation stability and cleanability. This test provides a good indication of how a product will run on a production line |
| Ice Water Resistance | <ul style="list-style-type: none"> • Used to determine an adhesive's ability to withstand wet and cold conditions • Parameters that can be varied include amount of adhesive, temperature and length of cure time after the adhesive is applied and length of soak time in ice cold water |
| Substrate Analysis | <ul style="list-style-type: none"> • Used to rate a label substrate in five different categories: curl, water absorption, % moisture, stiffness, thickness and dyne level |
| Set Speed | <ul style="list-style-type: none"> • Used to determine the length of time it takes for an adhesive to develop full fiber tear after application • Set Speed is the time it takes for the adhesive to lose water and build up the internal cohesion; time for adhesive to set is also affected by presence of water on the surface of the bottle (condensation) |
| Tack Test | <ul style="list-style-type: none"> • Automated piece of equipment that measures the tack of an adhesive in its wet, semi-dry and dry stage • Measures how well the adhesive will pick up a label and how the adhesive builds up tack over time |
| Scrub Tester | <ul style="list-style-type: none"> • Used to evaluate the ease of clean-up of water-based adhesives from various rubbers and plastics used in/on the labelling application equipment |
| Gravure Hot Melt Coater | <ul style="list-style-type: none"> • Used to prepare samples to create an adhesive bond between poly label stock and includes a gravure roller which applies a diamond pattern on the label substrate; this simulates a bond that is typically found in roll-fed hot melt bottle labeling applications • Bonds can then be evaluated for strength or adhesion under various environmental conditions |
| Environmental Chambers | <ul style="list-style-type: none"> • Bridgewater TCS is equipped with a temperature and humidity controlled room where the condition is kept constant at 72°F and 50% relative humidity • Equipped with several temperature & humidity chambers (Thermotrons) allowing controlled conditions as per end use specification - they hold large amounts of sample and can be programmed to run a specific cycle • Both temperature and humidity play a very important role in both water-based and hot melt adhesive performance |
| Analytical Test Capability | <ul style="list-style-type: none"> • Infrared Spectroscopy (identifies the chemical composition of a sample) • Scanning Electron Microscope (produces microscopic images of surface) • Gas Chromatography-Mass Spectrometry (sample composition) • Hot Stage Microscopy (thermal analysis under the microscope) |

HENKEL CORPORATION

10 Finderne Avenue, Suite B
 Bridgewater, NJ 08807
 Tel: 908.685.7000

www.na.henkel-adhesives.com/packaging

